## 18-Bit, 1.25MSPS <br> Analog-to-Digital Converter

## FEATURES

- Data Rate: 1.25MSPS
- Signal-to-Noise Ratio: 93dB
- Total Harmonic Distortion: -101dB
- Spurious-Free Dynamic Range: 103dB
- Linear Phase with 615 kHz Bandwidth
- Passband Ripple: $\pm 0.0025 \mathrm{~dB}$
- Adjustable FIFO Output Buffer (ADS1626 only)
- Selectable On-Chip Reference
- Directly Connects to TMS320C6000 DSPs
- Adjustable Power Dissipation: 150 to 515mW
- Power Down Mode
- Supplies: Analog $\quad+5 \mathrm{~V}$

Digital +3 V
Digital I/O +2.7V to +5.25 V

## APPLICATIONS

- Scientific Instruments
- Automated Test Equipment
- Data Acquisition
- Medical Imaging
- Vibration Analysis


## DESCRIPTION

The ADS1625 and ADS1626 are high-speed, high-precision, delta-sigma analog-to-digital converters (ADCs) with 18-bit resolution. The data rate is 1.25 mega samples per second (MSPS), the bandwidth ( -3 dB ) is 615 kHz , and passband ripple is less than $\pm 0.0025 \mathrm{~dB}$ (to 550 kHz ). Both devices offer the same outstanding performance at these speeds with a signal-to-noise ratio up to 93dB, total harmonic distortion down to -101 dB , and a spurious-free dynamic range up to 103dB. The ADS1626 includes an adjustable first-in, first-out buffer (FIFO) for the output data.

The input signal is measured against a voltage reference that can be generated on-chip or supplied externally. The digital output data is provided over a simple parallel interface that easily connects to digital signal processors (DSPs). An out-of-range monitor reports when the input range has been exceeded. The ADS1625/6 operate from a +5 V analog supply (AVDD) and +3 V digital supply (DVDD). The digital I/O supply (IOVDD) operates from +2.7 to +5.25 V , enabling the digital interface to support a range of logic families. The analog power dissipation is set by an external resistor and can be reduced when operating at slower speeds. A power-down mode, activated by a digital I/O pin, shuts down all circuitry. The ADS1625/6 are offered in a TQFP-64 package using TI PowerPAD ${ }^{\text {M }}$ technology.

The ADS1625 and ADS1626, along with their 16-bit, 5MSPS counterparts, the ADS1605 and ADS1606, are well-suited for the demanding measurement requirements of scientific instrumentation, automated test equipment, data acquisition, and medical imaging.


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SBAS280C - JUNE 2003 - REVISED JUNE 2004

## ORDERING INFORMATION

| PRODUCT | PACKAGE-LEAD | PACKAGE DESIGNATOR(1) | SPECIFIED TEMPERATURE RANGE | PACKAGE MARKING | ORDERING NUMBER | TRANSPORT MEDIA, QUANTITY |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1625 | TQFP-64 <br> PowerPAD | PAP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | ADS1625I | ADS1625IPAPT | Tape and Reel, 250 |
|  |  |  |  |  | ADS1625IPAPR | Tape and Reel, 1000 |
| ADS1626 | TQFP-64 <br> PowerPAD | PAP | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | ADS1626I | ADS1626IPAPT | Tape and Reel, 250 |
|  |  |  |  |  | ADS1626IPAPR | Tape and Reel, 1000 |

(1) For the most current specifications and package information, refer to our web site at www.ti.com.

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted ${ }^{(1)}$

|  | ADS1625/26 | UNIT |
| :--- | :---: | :---: |
| AVDD to AGND | -0.3 to +6 | V |
| DVDD to DGND | -0.3 to +3.6 | V |
| IOVDD to DGND | -0.3 to +6 | V |
| AGND to DGND | -0.3 to +0.3 | V |
| Input Current | 100, Momentary | mA |
| Input Current | 10, Continuous | mA |
| Analog I/O to AGND | -0.3 to AVDD +0.3 | V |
| Digital I/O to DGND | -0.3 to IOVDD +0.3 | V |
| Maximum Junction Temperature | +150 | ${ }^{\circ} \mathrm{C}$ |
| Operating Temperature Range | -40 to +105 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature Range | -60 to +150 | ${ }^{\circ} \mathrm{C}$ |
| Lead Temperature (soldering, 10s) | +260 | ${ }^{\circ} \mathrm{C}$ |

(1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those specified is not implied.

## PRODUCT FAMILY

| PRODUCT | RESOLUTION | DATA RATE | FIFO? |
| :---: | :---: | :---: | :---: |
| ADS1605 | 16 Bits | 5.0 MSPS | No |
| ADS1606 | 16 Bits | 5.0 MSPS | Yes |
| ADS1625 | 18 Bits | 1.25 MSPS | No |
| ADS1626 | 18 Bits | 1.25 MSPS | Yes |

This integrated circuit can be damaged by ESD.
Texas Instruments recommends that all integrated
circuits be handled with appropriate precautions.
Failure to observe proper handling and installation procedures can
cause damage.
ESD damage can range from subtle performance degradation to
complete device failure. Precision integrated circuits may be more
susceptible to damage because very small parametric changes
could cause the device not to meet its published specifications.

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## ELECTRICAL CHARACTERISTICS

All specifications at $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}, \mathrm{AVDD}=5 \mathrm{~V}, \mathrm{DVDD}=\mathrm{IOVDD}=3 \mathrm{~V}, \mathrm{f} \mathrm{CLK}=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V} \mathrm{CM}=2.0 \mathrm{~V}$, FIFO disabled, and $\mathrm{R}_{\mathrm{BIAS}}=37 \mathrm{k} \Omega$, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Analog Input |  |  |  |  |  |
| Differential input voltage ( $\mathrm{V}_{\mathrm{IN}}$ ) <br> (AINP - AINN) | OdBFS | $\pm 1.545 V_{\text {REF }}$ |  |  | V |
|  | -2dBFS | $\pm 1.227 \mathrm{~V}_{\text {REF }}$ |  |  | V |
|  | -6dBFS | $\pm 0.774 \mathrm{~V}_{\text {REF }}$ |  |  | V |
|  | -20dBFS | $\pm 0.155 \mathrm{~V}_{\text {REF }}$ |  |  | V |
| Common-mode input voltage ( $\mathrm{V}_{\mathrm{CM}}$ ) $(\text { AINP + AINN }) / 2$ |  | 2.0 |  |  | V |
| Absolute input voltage (AINP or AINN with respect to AGND) | OdBFS | -0. |  | 4.7 | V |
|  | -2dBFS input and smaller | 0.1 |  | 4.2 | V |
| Dynamic Specifications |  |  |  |  |  |
| Data rate |  | $1.25\left(\frac{\mathrm{f}_{\mathrm{CLK}}}{40 \mathrm{MHz}}\right)$ |  |  | MSPS |
| Signal-to-noise ratio (SNR) | $\mathrm{fIN}=10 \mathrm{kHz},-2 \mathrm{dBFS}$ | 93 |  |  | dB |
|  | $\mathrm{fin}^{\text {a }}=10 \mathrm{kHz},-6 \mathrm{dBFS}$ | 90 |  |  | dB |
|  | $\mathrm{fIN}^{\text {a }}$ 10kHz, -20 dBFS | 76 |  |  | dB |
|  | $\mathrm{fIN}=100 \mathrm{kHz},-2 \mathrm{dBFS}$ | 93 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{kHz},-6 \mathrm{dBFS}$ | 90 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{I}} \mathrm{N}=100 \mathrm{kHz},-20 \mathrm{dBFS}$ | $70 \quad 76$ |  |  | dB |
|  | $\mathrm{fIN}=500 \mathrm{kHz},-2 \mathrm{dBFS}$ | 93 |  |  | dB |
|  | $\mathrm{fiN}^{\mathrm{I}}=500 \mathrm{kHz},-6 \mathrm{dBFS}$ | 90 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{IN}}=500 \mathrm{kHz},-20 \mathrm{dBFS}$ | 76 |  |  | dB |
| Total harmonic distortion (THD) | $\mathrm{fiN}^{\mathrm{N}}=10 \mathrm{kHz},-2 \mathrm{dBFS}$ | -101 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz},-6 \mathrm{dBFS}$ | -103 |  |  | dB |
|  | $\mathrm{fIN}^{\text {I }}=10 \mathrm{kHz},-20 \mathrm{dBFS}$ | -96 |  |  | dB |
|  | $\mathrm{fIN}=100 \mathrm{kHz},-2 \mathrm{dBFS}$ | -95 |  |  | dB |
|  | $\mathrm{fIN}^{\text {/ }}$ = 100kHz, -6 dBFS | -101 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{kHz},-20 \mathrm{dBFS}$ | -98 -90 |  |  | dB |
|  | $\mathrm{fIN}=500 \mathrm{kHz},-2 \mathrm{dBFS}$ | -114 |  |  | dB |
|  | $\mathrm{fIN}=500 \mathrm{kHz},-6 \mathrm{dBFS}$ | -110 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{IN}}=500 \mathrm{kHz},-20 \mathrm{dBFS}$ | -96 |  |  | dB |
| Signal-to-noise and distortion (SINAD) | $\mathrm{fIN}=10 \mathrm{kHz},-2 \mathrm{dBFS}$ | 92 |  |  | dB |
|  | $\mathrm{fin}^{\mathrm{N}}=10 \mathrm{kHz},-6 \mathrm{dBFS}$ | 89 |  |  | dB |
|  | $\mathrm{fIN}^{\text {a }}$ = 10kHz, -20 dBFS | 76 |  |  | dB |
|  | $\mathrm{fIN}=100 \mathrm{kHz},-2 \mathrm{dBFS}$ | 91 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{IN}}=100 \mathrm{kHz},-6 \mathrm{dBFS}$ | 89 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{I}} \mathrm{N}=100 \mathrm{kHz},-20 \mathrm{dBFS}$ | $69 \quad 76$ |  |  | dB |
|  | $\mathrm{fiN}^{\text {/ }}=500 \mathrm{kHz},-2 \mathrm{dBFS}$ | 93 |  |  | dB |
|  | $\mathrm{fIN}^{\text {I }}$ 500kHz, -6 dBFS | 90 |  |  | dB |
|  | $\mathrm{f}_{\mathrm{IN}}=500 \mathrm{kHz},-20 \mathrm{dBFS}$ | 76 |  |  | dB |

## ELECTRICAL CHARACTERISTICS (continued)

All specifications at $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}, \mathrm{AVDD}=5 \mathrm{~V}$, $\mathrm{DVDD}=\mathrm{IOVDD}=3 \mathrm{~V}, \mathrm{f} \mathrm{CLK}=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.0 \mathrm{~V}$, FIFO disabled, and $R_{B I A S}=37 \mathrm{k} \Omega$, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | MIN TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: |
| Spurious-free dynamic range (SFDR) | $\mathrm{f}_{\mathrm{IN}}=10 \mathrm{kHz},-2 \mathrm{dBFS}$ | 104 |  | dB |
|  | $\mathrm{fIN}^{\mathrm{N}}=10 \mathrm{kHz},-6 \mathrm{dBFS}$ | 106 |  | dB |
|  | $\mathrm{fIN}=10 \mathrm{kHz},-20 \mathrm{dBFS}$ | 99 |  | dB |
|  | $\mathrm{fIN}=100 \mathrm{kHz},-2 \mathrm{dBFS}$ | 97 |  | dB |
|  | $\mathrm{fIN}=100 \mathrm{kHz},-6 \mathrm{dBFS}$ | 103 |  | dB |
|  | $\mathrm{fIN}=100 \mathrm{kHz},-20 \mathrm{dBFS}$ | 92102 |  | dB |
|  | $\mathrm{fIN}=500 \mathrm{kHz},-2 \mathrm{dBFS}$ | 120 |  | dB |
|  | $\mathrm{fIN}^{\text {a }}$ = 500kHz, -6 dBFS | 113 |  | dB |
|  | $\mathrm{fIN}=500 \mathrm{kHz},-20 \mathrm{dBFS}$ | 99 |  | dB |
| Intermodulation distortion (IMD) | $\begin{aligned} & \mathrm{f}_{1}=495 \mathrm{kHz},-2 \mathrm{dBFS} \\ & \mathrm{f}_{2}=505 \mathrm{kHz},-2 \mathrm{dBFS} \end{aligned}$ | -98 |  | dB |
| Aperture delay |  | 4 |  | ns |
| Digital Filter Characteristics |  |  |  |  |
| Pass band |  | 0 | $50\left(\frac{\mathrm{f}_{\text {CLK }}}{40 \mathrm{MHz}}\right)$ | kHz |
| Pass band ripple |  |  | $\pm 0.0025$ | dB |
| Pass band transition | -0.1dB attenuation | $575\left(\frac{\mathrm{f}_{\text {CLK }}}{40 \mathrm{MHz}}\right)$ |  | kHz |
|  | -3.0dB attenuation | $615\left(\frac{\mathrm{f}_{\text {CLK }}}{40 \mathrm{MHz}}\right)$ |  | kHz |
| Stop band |  | $0.7\left(\frac{\mathrm{f}_{\text {CLK }}}{40 \mathrm{MHz}}\right)$ |  | MHz |
| Stop band attenuation |  | 72 |  | dB |
| Group delay |  | $20.8\left(\frac{40 \mathrm{MHz}}{\mathrm{f}_{\text {CLK }}}\right)$ |  | $\mu \mathrm{s}$ |
| Settling time | To $\pm 0.001 \%$ | $36.8\left(\frac{40 \mathrm{MHz}}{\mathrm{f}_{\text {CLK }}}\right)$ |  | $\mu \mathrm{S}$ |
| Static Specifications |  |  |  |  |
| Resolution |  | 18 |  | Bits |
| No missing codes |  | 18 |  | Bits |
| Input referred noise |  | 1.5 |  | LSB, rms |
| Integral nonlinearity | -2.0dBFS signal | 3.5 |  | LSB |
| Differential nonlinearity |  | $\pm 0.5$ |  | LSB |
| Offset error |  | 0.05 |  | \%FSR |
| Offset error drift |  | 1 |  | ppmFSR $/{ }^{\circ} \mathrm{C}$ |
| Gain error |  | 0.25 |  | \% |
| Gain error drift | Excluding reference drift | 10 |  | ppm/ ${ }^{\circ} \mathrm{C}$ |
| Common-mode rejection | at DC | 75 |  | dB |
| Power-supply rejection | at DC | 65 |  | dB |

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## ELECTRICAL CHARACTERISTICS (continued)

All specifications at $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, AVDD $=5 \mathrm{~V}$, DVDD $=I \mathrm{IVDD}=3 \mathrm{~V}$, $\mathrm{f} \mathrm{CLK}=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.0 \mathrm{~V}$, FIFO disabled, and $R_{\text {BIAS }}=37 \mathrm{k} \Omega$, unless otherwise noted.

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Voltage Reference(1) |  |  |  |  |  |
| VREF $=($ VREFP - VREFN) |  | 2.5 | 3.0 | 3.2 | V |
| VREFP |  | 3.75 | 4.0 | 4.25 | V |
| VREFN |  | 0.75 | 1.0 | 1.25 | V |
| VMID |  | 2.3 | 2.5 | 2.8 | V |
| $\mathrm{V}_{\text {REF }}$ drift | Internal reference ( $\overline{\text { REFEN }}=$ low) |  | 50 |  | ppm $/{ }^{\circ} \mathrm{C}$ |
| Startup time | Internal reference ( $\overline{\text { REFEN }}=$ low) |  | 15 |  | ms |
| Clock Input |  |  |  |  |  |
| Frequency (fCLK) |  | 1 | 40 | 50 | MHz |
| Duty Cycle | $\mathrm{f}^{\text {CLK }}=40 \mathrm{MHz}$ | 45 |  | 55 | \% |
| Digital Input/Output |  |  |  |  |  |
| $\mathrm{V}_{\mathrm{IH}}$ |  | 0.7 IOVDD |  | IOVDD | V |
| $\mathrm{V}_{\text {IL }}$ |  | DGND |  | 0.3 IOVDD | V |
| $\mathrm{V}_{\mathrm{OH}}$ | $\mathrm{IOH}=50 \mu \mathrm{~A}$ | 0.8 IOVDD |  |  | V |
| VOL | $\mathrm{IOL}=50 \mu \mathrm{~A}$ |  |  | 0.2 IOVDD | V |
| Input leakage | DGND < V DIGIN < IOVDD |  |  | $\pm 10$ | $\mu \mathrm{A}$ |
| Power-Supply Requirements |  |  |  |  |  |
| AVDD |  | 4.75 |  | 5.25 | V |
| DVDD |  | 2.7 |  | 3.3 | V |
| IOVDD |  | 2.7 |  | 5.25 | V |
| AVDD current (IAVDD) | $\overline{\text { REFEN }}=$ low |  | 110 | 135 | mA |
|  | $\overline{\text { REFEN }}=$ high |  | 85 | 105 | mA |
| DVDD current (IDVDD) |  |  | 27 | 35 | mA |
| IOVDD current (IIOVDD) | IOVDD = 3V |  | 3 | 5 | mA |
| Power dissipation | $\begin{aligned} & \mathrm{AVDD}=5 \mathrm{~V}, \mathrm{DVDD}=3 \mathrm{~V}, \text { IOVDD }=3 \mathrm{~V}, \\ & \text { REFEN }=\text { high } \end{aligned}$ |  | 515 | 645 | mW |
|  | $\overline{\mathrm{PD}}=$ low, CLK disabled |  | 5 |  | mW |
| Temperature Range |  |  |  |  |  |
| Specified |  | -40 |  | +85 | ${ }^{\circ} \mathrm{C}$ |
| Operating |  | -40 |  | +105 | ${ }^{\circ} \mathrm{C}$ |
| Storage |  | -60 |  | +150 | ${ }^{\circ} \mathrm{C}$ |
| Thermal Resistance, $\theta_{\mathrm{JA}}$ | PowerPAD soldered to PCB with $20 z$. trace and copper pad. |  | 25 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $\theta \mathrm{JC}$ |  |  | 0.5 |  | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

(1) The specification limits for VREF, VREFP, VREFN, and VMID apply when using the internal or an external reference. The internal reference voltages are bounded by the limits shown. When using an external reference, the limits indicate the allowable voltages that can be applied to the reference pins.

## DEFINITIONS

## Absolute Input Voltage

Absolute input voltage, given in volts, is the voltage of each analog input (AINN or AINP) with respect to AGND.

## Aperture Delay

Aperture delay is the delay between the rising edge of CLK and the sampling of the input signal.

## Common-Mode Input Voltage

Common-mode input voltage ( $\mathrm{V}_{\mathrm{CM}}$ ) is the average voltage of the analog inputs:

$$
\frac{(\text { AINP }+ \text { AINN })}{2}
$$

## Differential Input Voltage

Differential input voltage ( $\mathrm{V}_{\mathrm{IN}}$ ) is the voltage difference between the analog inputs: (AINP-AINN).

## Differential Nonlinearity (DNL)

DNL, given in least-significant bits (LSB) of the output code, is the maximum deviation of the output code step sizes from the ideal value of 1LSB.

## Full-Scale Range (FSR)

FSR is the difference between the maximum and minimum measurable input signals. For the ADS1625, $\mathrm{FSR}=2 \times 1.57 \mathrm{~V}_{\mathrm{REF}}$.

## Gain Error

Gain error, given in \%, is the error of the full-scale input signal with respect to the ideal value.

## Gain Error Drift

Gain error drift, given in $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$, is the drift over temperature of the gain error. The gain error is specified as the larger of the drift from ambient ( $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ) to the minimum or maximum operating temperatures.

## Integral Nonlinearity (INL)

INL, given in least significant bits (LSB) of the output code, is the maximum deviation of the output codes from a bestfit line.

## Intermodulation Distortion (IMD)

IMD, given in dB , is measured while applying two input signals of the same magnitude, but with slightly different frequencies. It is calculated as the difference between the rms amplitude of the input signal to the rms amplitude of the peak spurious signal.

## Offset Error

Offset Error, given in \% of FSR, is the output reading when the differential input is zero.

## Offset Error Drift

Offset error drift, given in ppm of $\mathrm{FSR} /{ }^{\circ} \mathrm{C}$, is the drift over temperature of the offset error. The offset error is specified as the larger of the drift from ambient $\left(\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}\right)$ to the minimum or maximum operating temperatures.

## Signal-to-Noise Ratio (SNR)

SNR, given in dB, is the ratio of the rms value of the input signal to the sum of all the frequency components below $\mathrm{f}_{\mathrm{CLK}} / 2$ (the Nyquist frequency) excluding the first six harmonics of the input signal and the dc component.

## Signal-to-Noise and Distortion (SINAD)

SINAD, given in dB , is the ratio of the rms value of the input signal to the sum of all the frequency components below $\mathrm{f}_{\mathrm{CLK}} / 2$ (the Nyquist frequency) including the harmonics of the input signal but excluding the dc component.

## Spurious Free Dynamic Range (SFDR)

SFDR, given in dB , is the difference between the rms amplitude of the input signal to the rms amplitude of the peak spurious signal.

## Total Harmonic Distortion (THD)

THD, given in dB , is the ratio of the sum of the rms value of the first six harmonics of the input signal to the rms value of the input signal.

PIN ASSIGNMENTS


Terminal Functions

| TERMINAL |  | TYPE | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| NAME | NO. |  |  |
| AGND | 1, 3, 6, 9, 11, 55, 57 | Analog | Analog ground |
| AVDD | 2, 7, 10, 12, 58 | Analog | Analog supply |
| AINN | 4 | Analog input | Negative analog input |
| AINP | 5 | Analog input | Positive analog input |
| RBIAS | 8 | Analog | Terminal for external analog bias setting resistor |
| $\overline{\text { REFEN }}$ | 13 | Digital input: active low | Internal reference enable. Internal pull-down resistor of 170k $\Omega$ to DGND. |
| NC | 16, 45, 49, 50 |  | Must be left unconnected |
| $\overline{\text { PD }}$ | 17 | Digital input: active low | Power down all circuitry. Internal pull-up resistor of 170k to DGND. |
| DVDD | 18, 26, 52 | Digital | Digital supply |
| DGND | 15, 19, 25, 51, 54 | Digital | Digital ground |
| RESET | 20 | Digital input: active low | Reset digital filter |
| $\overline{\mathrm{CS}}$ | 21 | Digital input: active low | Chip select |
| $\overline{\mathrm{RD}}$ | 22 | Digital input: active low | Read enable |
| OTR | 23 | Digital output | Active when analog inputs are out of range |
| $\overline{\text { DRDY }}$ | 24 | Digital output: active low | Data ready on falling edge |
| DOUT [17:0] | 27-44 | Digital output | Data output. DOUT[17] is the MSB and DOUT[0] is the LSB. |
| FIFO_LEV[2:0] | 46-48 | Digital input | FIFO level (for the ADS1626 only). FIFO_LEV[2] is MSB. <br> NOTE: These terminals must be left unconnected on the ADS1625. |
| IOVDD | 14, 53 | Digital | Digital I/O supply |
| CLK | 56 | Digital input | Clock input |
| VCAP | 59 | Analog | Terminal for external bypass capacitor connection to internal bias voltage |
| VREFN | 60, 61 | Analog | Negative reference voltage |
| VMID | 62 | Analog | Midpoint voltage |
| VREFP | 63, 64 | Analog | Positive reference voltage |

## PARAMETER MEASUREMENT INFORMATION



Figure 1. Data Retrieval Timing (ADS1625, ADS1626 with FIFO Disabled)


Figure 2. DOUT Inactive/Active Timing (ADS1625, ADS1626 with FIFO Disabled)

TIMING REQUIREMENTS FOR FIGURE 1 AND FIGURE 2

| SYMBOL | DESCRIPTION | MIN | TYP |
| :---: | :--- | ---: | :---: |
| $\mathrm{t}_{1}$ | CLK period (1/fCLK) | 20 | 25 |
| $1 / \mathrm{t}_{1}$ | mCLK | 1000 | ns |
| $\mathrm{t}_{2}$ | CLK pulse width, high or low | 40 | 50 |
| $\mathrm{t}_{3}$ | Rising edge of CLK to $\overline{\text { DRDY }}$ low | 10 |  |
| $\mathrm{t}_{4}$ | $\overline{\text { DRDY }}$ pulse width high or low | ns |  |
| $\mathrm{t}_{5}$ | Falling edge of $\overline{\mathrm{DRDY}}$ to data invalid | 10 | ns |
| $\mathrm{t}_{6}$ | Falling edge of $\overline{\mathrm{DRDY}}$ to data valid | $16 \mathrm{t}_{1}$ | ns |
| $\mathrm{t}_{7}$ | Rising edge of $\overline{\mathrm{RD}}$ and/or $\overline{\mathrm{CS}}$ inactive (high) to DOUT high impedance | 10 | ns |
| $\mathrm{t}_{8}$ | Falling edge of $\overline{\mathrm{RD}}$ and/or $\overline{\mathrm{CS}}$ active (low) to DOUT active. | 15 | ns |

NOTE: DOUT[17:0] and $\overline{\text { DRDY }}$ load $=10 \mathrm{pF}$.


Figure 3. Reset Timing (ADS1625, ADS1626 with FIFO Disabled)

TIMING REQUIREMENTS FOR FIGURE 3

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| t3 | Rising edge of CLK to $\overline{\text { DRDY }}$ low |  | 10 |  | ns |
| t9 | $\overline{\text { RESET pulse width }}$ | 50 |  |  | ns |
| $\mathrm{t}_{10}$ | Delay from $\overline{\mathrm{RESET}}$ active (low) to $\overline{\text { DRDY }}$ forced high and DOUT forced low |  | 9 |  | ns |
| $\mathrm{t}_{11}$ | $\overline{\text { RESET rising edge to falling edge of CLK }}$ | -5 |  | 10 | ns |
| $\mathrm{t}_{12}$ | Delay from DOUT active to valid DOUT (settling to 0.001\%) |  | 46 |  | $\overline{\overline{D R D Y}}$ Cycles |

NOTE: DOUT[17:0] and $\overline{\text { DRDY }}$ load $=10 \mathrm{pF}$.

(1) $\overline{C S}$ may be tied low.
(2) The number of data readings (DL) is set by the FIFO level.

Figure 4. Data Retrieval Timing (ADS1626 with FIFO Enabled)


Figure 5. DOUT Inactive/Active Timing (ADS1626 with FIFO Enabled)

TIMING REQUIREMENTS FOR FIGURE 4 AND FIGURE 5

| SYMBOL | DESCRIPTION | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{t}_{1}$ | CLK period (1/fCLK) | 20 | 25 | 1000 | ns |
| $\mathrm{t}_{2}$ | CLK pulse width, high or low | 10 |  |  | ns |
| ${ }_{7}$ | Rising edge of $\overline{\mathrm{RD}}$ and/or $\overline{\mathrm{CS}}$ inactive (high) to DOUT high impedance |  | 7 | 15 | ns |
| t8 | Falling edge of $\overline{\mathrm{RD}}$ and/or $\overline{\mathrm{CS}}$ active (low) to DOUT active. |  | 7 | 15 | ns |
| $\mathrm{t}_{13}$ | Rising edge of CLK to $\overline{\text { DRDY }}$ high |  | 12 |  | ns |
| $\mathrm{t}_{14}$ | $\overline{\text { DRDY }}$ period | $32 \times$ FIFO Level ${ }^{(1)}$ |  |  | $\begin{gathered} \text { CLK } \\ \text { Cycles } \end{gathered}$ |
| $\mathrm{t}_{15}$ | $\overline{\text { DRDY }}$ positive pulse width | 1 |  |  | $\begin{gathered} \text { CLK } \\ \text { Cycles } \end{gathered}$ |
| $\mathrm{t}_{16}$ | $\overline{\mathrm{RD}}$ high hold time after $\overline{\mathrm{DRDY}}$ goes low | 0 |  |  | ns |
| $\mathrm{t}_{17}$ | $\overline{\mathrm{CS}}$ low before $\overline{\mathrm{RD}}$ goes low | 0 |  |  | ns |
| $\mathrm{t}_{18}$ | $\overline{\mathrm{RD}}$ negative pulse width | 10 |  |  | ns |
| $\mathrm{t}_{19}$ | $\overline{\mathrm{RD}}$ positive pulse width | 10 |  |  | ns |
| $\mathrm{t}_{20}$ | $\overline{\mathrm{RD}}$ high before $\overline{\mathrm{DRDY}}$ toggles | 2 |  |  | $\begin{gathered} \text { CLK } \\ \text { Cycles } \end{gathered}$ |
| $\mathrm{t}_{21}$ | $\overline{\mathrm{RD}}$ high before $\overline{\mathrm{CS}}$ goes high | 0 |  |  | ns |

NOTE: DOUT[17:0] and $\overline{\text { DRDY }}$ load $=10 \mathrm{pF}$.
(1) See FIFO section for more details.


Figure 6. Reset Timing (ADS1626 with FIFO Enabled)

## TIMING REQUIREMENTS FOR FIGURE 6

| SYMBOL | DESCRIPTION | MIN TYP MAX | UNIT |
| :---: | :---: | :---: | :---: |
| t9 | RESET pulse width | 50 | ns |
| $\mathrm{t}_{11}$ | $\overline{\text { RESET }}$ rising edge to falling edge of CLK | -5 10 | ns |
| $t_{23}$ | $\overline{\mathrm{RD}}$ pulse low after $\overline{\mathrm{RESET}}$ goes high | 32 | CLK Cycles |
| $\mathrm{t}_{24}$ | $\overline{\mathrm{RD}}$ pulse high before first $\overline{\mathrm{DRDY}}$ pulse after $\overline{\mathrm{RESET}}$ goes high | 32 | $\begin{gathered} \text { CLK } \\ \text { Cycles } \end{gathered}$ |
| $\mathrm{t}_{25}$ | $\overline{\text { DRDY }}$ low after $\overline{\text { RESET }}$ goes low | $32 \times($ FIFO level +1 ) | CLK Cycles |
| $\mathrm{t}_{26}$ | Delay from $\overline{\text { RESET }}$ high to valid DOUT (settling to 0.001\%) | See Table 4 | $\begin{aligned} & \hline \overline{\text { DRDY }} \\ & \text { Cycles } \end{aligned}$ |

## TYPICAL CHARACTERISTICS

All specifications at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{AVDD}=5 \mathrm{~V}, \mathrm{DVDD}=I O V D D=3 \mathrm{~V}, \mathrm{f} \mathrm{CLK}=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.0 \mathrm{~V}$, and $\mathrm{R}_{\mathrm{BI}} \mathrm{AS}=37 \mathrm{k} \Omega$, unless otherwise noted.







## TYPICAL CHARACTERISTICS (continued)

All specifications at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{AVDD}=5 \mathrm{~V}, \mathrm{DVDD}=I O V D D=3 \mathrm{~V}, \mathrm{f} C L K=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.0 \mathrm{~V}$, and $\mathrm{R}_{\mathrm{BIAS}}=37 \mathrm{k} \Omega$, unless otherwise noted.


SIGNAL-TO-NOISE RATIO, TOTAL HARMONIC DISTORTION, AND SPURIOUS-FREE DYNAMIC RANGE vs INPUT SIGNALAMPLITUDE


TOTAL HARMONIC DISTORTION
vs INPUT FREQUENCY




SPURIOUS-FREE DYNAMIC RANGE vs INPUT FREQUENCY


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## TYPICAL CHARACTERISTICS (continued)

All specifications at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{AVDD}=5 \mathrm{~V}, \mathrm{DVDD}=I O V D D=3 \mathrm{~V}, \mathrm{f} C L K=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V}_{\mathrm{C}}=2.0 \mathrm{~V}$, and RBIAS $=37 \mathrm{k} \Omega$, unless otherwise noted.


SPURIOUS-FREE DYNAMIC RANGE vs INPUT COMMON-MODE VOLTAGE



TOTAL HARMONIC DISTORTION vs INPUT COMMON-MODE VOLTAGE



SPURIOUS-FREE DYNAMIC RANGE vs CLK FREQUENCY


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## TYPICAL CHARACTERISTICS (continued)

All specifications at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}, \mathrm{AVDD}=5 \mathrm{~V}, \mathrm{DVDD}=I O V D D=3 \mathrm{~V}$, $\mathrm{f} C L K=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.0 \mathrm{~V}$, and $\mathrm{R}_{\mathrm{BI}} \mathrm{AS}=37 \mathrm{k} \Omega$, unless otherwise noted.


SPURIOUS-FREE DYNAMIC RANGE



TOTAL HARMONIC DISTORTION vs TEMPERATURE


POWER-SUPPLY CURRENT vs TEMPERATURE



## TYPICAL CHARACTERISTICS (continued)

All specifications at $T_{A}=25^{\circ} \mathrm{C}, \mathrm{AVDD}=5 \mathrm{~V}, \mathrm{DVDD}=I O V D D=3 \mathrm{~V}, \mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}$, External $\mathrm{V}_{\mathrm{REF}}=+3 \mathrm{~V}, \mathrm{~V}_{\mathrm{CM}}=2.0 \mathrm{~V}$, and $\mathrm{R}_{\mathrm{BI}}$, $\mathrm{AS}=37 \mathrm{k} \Omega$, unless otherwise noted.



## OVERVIEW

The ADS1625 and ADS1626 are high-performance delta-sigma ADCs with a default oversampling ratio of 32. The modulator uses an inherently stable 2-1-1 pipelined delta-sigma modulator architecture incorporating proprietary circuitry that allows for very linear high-speed operation. The modulator samples the input signal at 40MSPS (when $\mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}$ ). A low-ripple, linear-phase digital filter decimates the modulator output to provide data output word rates of 1.25MSPS with a signal passband out to 615 kHz .

Conceptually, the modulator and digital filter measure the differential input signal, $\mathrm{V}_{I N}=($ AINP - AINN $)$, against the scaled differential reference, $\mathrm{V}_{\text {REF }}=(\mathrm{VREFP}-\mathrm{VREFN})$, as shown in Figure 7. The voltage reference can either be generated internally or supplied externally. An 18-bit parallel data bus, designed for direct connection to DSPs, outputs the data. A separate power supply for the I/O allows flexibility for interfacing to different logic families. Out-ofrange conditions are indicated with a dedicated digital output pin. Analog power dissipation is controlled using an external resistor. This allows reduced dissipation when operating at slower speeds. When not in use, power consumption can be dramatically reduced using the $\overline{\mathrm{PD}}$ pin.

The ADS1626 incorporates an adjustable FIFO for the output data. The level of the FIFO is set by the FIFO_LEV[2:0] pins. Other than the FIFO, the ADS1625 and ADS1626 are identical, and together are referred to as the ADS1625/6.

## ANALOG INPUTS (AINP, AINN)

The ADS1625/6 measures the differential signal, $\mathrm{V}_{\text {IN }}=($ AINP - AINN $)$, against the differential reference, $\mathrm{V}_{\text {REF }}=(\mathrm{VREFP}-\mathrm{VREFN})$. The reference is scaled internally so that the full-scale differential input voltage is $1.545 \mathrm{~V}_{\text {REF. }}$. That is, the most positive measurable differential input is $1.545 \mathrm{~V}_{\text {REF }}$, which produces the most
positive digital output code of 7FFFh. Likewise, the most negative measurable differential input is $-1.545 \mathrm{~V}_{\text {REF }}$, which produces the most negative digital output code of 8000 h .
The ADS1625/6 supports a very wide range of input signals. For $\mathrm{V}_{\text {REF }}=3 \mathrm{~V}$, the full scale input voltages are $\pm 4.6 \mathrm{~V}$. Having such a wide input range makes out-of-range signals unlikely. However, should an out-of-range signal occur, digital output OTR will go high.
To achieve the highest analog performance, it is recommended that the inputs be limited to $\pm 1.227 \mathrm{~V}_{\text {REF }}$ (-2dBFS). For $\mathrm{V}_{\text {REF }}=3 \mathrm{~V}$, the corresponding recommended input range is $\pm 3.68 \mathrm{~V}$.
The analog inputs must be driven with a differential signal to achieve optimum performance. The recommended common-mode voltage of the input signal, $\mathrm{V}_{\mathrm{CM}}=\frac{\text { AINP }+ \text { AINN }}{2}$, is 2.0 V . For signals larger than $-2 d B F S$, the input common-mode voltage needs to be raised in order to meet the absolute input voltage specifications. The typical characteristics show how performance varies with input common-mode voltage.

In addition to the differential and common-mode input voltages, the absolute input voltage is also important. This is the voltage on either input (AINP or AINN) with respect to AGND. The range for this voltage is:

$$
-0.1 \mathrm{~V}<(\text { AINN or AINP })<4.6 \mathrm{~V}
$$

If either input is taken below -0.1 V , ESD protection diodes on the inputs will turn on. Exceeding 4.7 V on either input will result in degradation in the linearity performance. ESD protection diodes will also turn on if the inputs are taken above AVDD (+5V).

For signals below -2 dBFS , the recommended absolute input voltage is:

$$
0.1 \mathrm{~V}<(\text { AINN or AINP })<4.2 \mathrm{~V}
$$

Keeping the inputs within this range provides for optimum performance.


Figure 7. Conceptual Block Diagram

## INPUT CIRCUITRY

The ADS1625/6 uses switched-capacitor circuitry to measure the input voltage. Internal capacitors are charged by the inputs and then discharged internally with this cycle repeating at the frequency of CLK. Figure 8 shows a conceptual diagram of these circuits. Switches S 2 represent the net effect of the modulator circuitry in discharging the sampling capacitors, the actual implementation is different. The timing for switches S 1 and S 2 is shown in Figure 9.


Figure 8. Conceptual Diagram of Internal Circuitry Connected to the Analog Inputs


Figure 9. Timing for the Switches in Figure 2

## DRIVING THE INPUTS

The external circuits driving the ADS1625/6 inputs must be able to handle the load presented by the switching capacitors within the ADS1625/6. Input switches S1 in Figure 9 are closed approximately one-half of the sampling period, $\mathrm{t}_{\text {sample }}$, allowing only $\approx 12 \mathrm{~ns}$ for the internal capacitors to be charged by the inputs, when $\mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}$.

Figure 10 and Figure 11 show the recommended circuits when using single-ended or differential op amps, respectively. The analog inputs must be driven differentially to achieve optimum performance. The
external capacitors, between the inputs and from each input to AGND, improve linearity and should be placed as close to the pins as possible. Place the drivers close to the inputs and use good capacitor bypass techniques on their supplies; usually a smaller high-quality ceramic capacitor in parallel with a larger capacitor. Keep the resistances used in the driver circuits low-thermal noise in the driver circuits degrades the overall noise performance. When the signal can be ac-coupled to the ADS1625/6 inputs, a simple RC filter can set the input common-mode voltage. The ADS1625/6 is a high-speed, high-performance ADC. Special care must be taken when selecting the test equipment and setup used with this device. Pay particular attention to the signal sources to ensure they do not limit performance when measuring the ADS1625/6.


Figure 10. Recommended Driver Circuit Using the OPA2822


Figure 11. Recommended Driver Circuits Using the THS4503 Differential Amplifier

ADS1625

## REFERENCE INPUTS (VREFN, VREFP, VMID)

The ADS1625 can operate from an internal or external voltage reference. In either case, reference voltage $\mathrm{V}_{\text {REF }}$ is set by the differential voltage between VREFN and VREFP: $V_{\text {REF }}=($ VREFP - VREFN). VREFP and VREFN each use two pins, which should be shorted together. VMID equals approximately 2.5 V and is used by the modulator. VCAP connects to an internal node, and must also be bypassed with an external capacitor. For the best analog performance, it is recommended that an external reference voltage ( $V_{\text {REF }}$ ) of 3.0 V be used.

## INTERNAL REFERENCE ( $\overline{\operatorname{REFEN}}=$ LOW)

To use the internal reference, set the REFEN pin low. This activates the internal circuitry that generates the reference voltages. The internal reference voltages are applied to the pins. Good bypassing of the reference pins is critical to achieve optimum performance and is done by placing the bypass capacitors as close to the pins as possible. Figure 12 shows the recommended bypass capacitor values. Use high quality ceramic capacitors for the smaller values. Avoid loading the internal reference with external circuitry. If the ADS1625/6 internal reference is to be used by other circuitry, buffer the reference voltages to prevent directly loading the reference pins.


Figure 12. Reference Bypassing When Using the Internal Reference

## EXTERNAL REFERENCE ( $\overline{\text { REFEN }}=$ HIGH)

To use an external reference, set the REFEN pin high. This deactivates the internal generators for VREFP, VREFN and VMID, and saves approximately 25 mA of current on the analog supply (AVDD). The voltages applied to these pins must be within the values specified in the Electrical Characteristics table. Typically VREFP $=4 \mathrm{~V}, \mathrm{VMID}=2.5 \mathrm{~V}$
and VREFN $=1 \mathrm{~V}$. The external circuitry must be capable of providing both a dc and a transient current. Figure 13 shows a simplified diagram of the internal circuitry of the reference when the internal reference is disabled. As with the input circuitry, switches S1 and S2 open and close as shown in Figure 9.


Figure 13. Conceptual Internal Circuitry for the Reference When REFEN = High

Figure 14 shows the recommended circuitry for driving these reference inputs. Keep the resistances used in the buffer circuits low to prevent excessive thermal noise from degrading performance. Layout of these circuits is critical, make sure to follow good high-speed layout practices. Place the buffers, and especially the bypass capacitors, as close to the pins as possible. VCAP is unaffected by the setting on REFEN and must be bypassed when using the internal or an external reference.


Figure 14. Recommended Buffer Circuit When Using an External Reference
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## CLOCK INPUT (CLK)

The ADS1625/6 requires an external clock signal to be applied to the CLK input pin. The sampling of the modulator is controlled by this clock signal. As with any high-speed data converter, a high quality clock is essential for optimum performance. Crystal clock oscillators are the recommended CLK source; other sources, such as frequency synthesizers, are usually not adequate. Make sure to avoid excess ringing on the CLK input; keeping the trace as short as possible will help.

Measuring high-frequency, large-amplitude signals requires tight control of clock jitter. The uncertainty during sampling of the input from clock jitter limits the maximum achievable SNR. This effect becomes more pronounced with higher frequency and larger magnitude inputs. Fortunately, the ADS1625/6 oversampling topology reduces clock jitter sensitivity over that of Nyquist rate converters like pipeline and successive approximation converters by a factor of $\sqrt{32}$.
In order to not limit the ADS1625/6 SNR performance, keep the jitter on the clock source below the values shown in Table 1. When measuring lower frequency and lower amplitude inputs, more CLK jitter can be tolerated. In determining the allowable clock source jitter, select the worst-case input (highest frequency, largest amplitude) that will be seen in the application.

Table 1. Maximum Allowable Clock Source Jitter for Different Input Signal Frequencies and Amplitude

| INPUT SIGNAL |  | MAXIMUM <br> ALLOWABLE <br> CLOCK SOURCE <br> JITTER (RMS) |
| :---: | :---: | :---: |
| MAXIMUM <br> FREQUENCY | MAXIMUM <br> AMPLITUDE |  |
| 500 kHz | -2 dB | 50 ps |
| 500 kHz | -20 dB | 35 ps |
| 100 kHz | -2 dB | 285 ps |
| 100 kHz | -20 dB |  |

## DATA FORMAT

The 18-bit output data is in binary two's complement format, as shown in Table 2. Under normal operation, the output codes range between 200A8h to 1FF57h. Signals less than $-1.545 \mathrm{~V}_{\text {REF }}$ will clip at 200A8h and likewise, signals greater than $1.545 \mathrm{~V}_{\text {REF }}$ will clip at 1 FF57h. For large step changes on the inputs, the output clips at the positive full-scale value of 1FFFFh (positive transients) or the negative full-scale value of 20000h (negative transients).

Table 2. Output Code Versus Input Signal

| INPUT SIGNAL <br> (INP - INN) | IDEAL OUTPUT <br> CODE(1) | OTR |
| :---: | :---: | :---: |
| $\geq+1.545 \mathrm{~V}_{\text {REF }}(>0 \mathrm{~dB})(2)$ | 1 FFFFh | 1 |
| $\geq+1.545 \mathrm{~V}_{\text {REF }}(0 \mathrm{~dB})$ | 1 FF57h | 0 |
| $\frac{+1.545 \mathrm{~V}_{\text {REF }}}{2^{17}-1}$ | 00001 h | 0 |
| 0 | 00000 h | 0 |
| $\frac{-1.545 \mathrm{~V}_{\text {REF }}}{2^{17}-1}$ | 3 FFFFh | 0 |
| $\leq-1.545 \mathrm{~V}_{\text {REF }}\left(\frac{2^{17}}{2^{17}-1}\right)$ | 200 A 8 h | 0 |
| $\leq-1.545 \mathrm{~V}_{\text {REF }}\left(\frac{2^{17}}{2^{17}-1}\right)$ |  | 20000 h |
| $(2)$ |  | 1 |

(1) Excludes effects of noise, INL, offset and gain errors.
(2) Large step inputs.

## OUT-OF-RANGE INDICATION (OTR)

If the output code on DOUT[17:0] exceeds the positive or negative full-scale, the out-of-range digital output OTR will go high on the falling edge of $\overline{\text { DRDY. When the output code }}$ returns within the full-scale range, OTR returns low on the falling edge of $\overline{\text { DRDY. }}$

## DATA RETRIEVAL

Data retrieval is controlled through a simple parallel interface. The falling edge of the $\overline{\text { DRDY }}$ output indicates new data is available. To activate the output bus, both $\overline{\mathrm{CS}}$ and $\overline{R D}$ must be low, as shown in Table 3. On the ADS1625, both of these signals can be tied low. On the ADS1626 with FIFO enabled, only $\overline{\mathrm{CS}}$ can be tied low because $\overline{\mathrm{RD}}$ must toggle to operate the FIFO. See the FIFO section for more details. Make sure the DOUT bus does not drive heavy loads (>20pF), as this will degrade performance. Use an external buffer when driving an edge connector or cables.

Table 3. Truth Table for $\overline{\mathbf{C S}}$ and $\overline{\mathrm{RD}}$

| $\overline{\mathbf{C S}}$ | $\overline{\mathbf{R D}}$ | DOUT[17:0] |
| :---: | :---: | :---: |
| 0 | 0 | Active |
| 0 | 1 | High impedance |
| 1 | 0 | High impedance |
| 1 | 1 | High impedance |

## RESETTING THE ADS1625

The ADS1625 and ADS1626 with FIFO disabled are asynchronously reset when the RESET pin is taken low. During reset, all of the digital circuits are cleared, DOUT[17:0] are forced low, and DRDY forced high. It is recommended that the RESET pin be released on the falling edge of CLK. Afterwards, $\overline{\text { DRDY goes low on the }}$ second rising edge of CLK. Allow $46 \overline{\text { DRDY }}$ cycles for the digital filter to settle before retrieving data. See Figure 3 for the timing specifications.

Reset can be used to synchronize multiple ADS1625s. All devices to be synchronized must use a common CLK input. With the CLK inputs running, pulse RESET on the falling edge of CLK, as shown in Figure 15. Afterwards, the converters will be converting synchronously with the DRDY outputs updating simultaneously. After synchronization, allow $46 \overline{\text { DRDY }}$ cycles ( $t_{12}$ ) for output data to fully settle.


Figure 15. Synchronizing Multiple Converters

## RESETTING THE ADS1626

The ADS1626 with the FIFO enabled requires a different reset sequence than the ADS1625, as shown in Figure 16. Ignore any DRDY toggles that occur while RESET is low. Release RESET on the rising edge of CLK, then afterwards toggle $\overline{R D}$ to complete the reset sequence.


Figure 16. Resetting the ADS1626 with the FIFO Enabled

After resetting, the settling time for the ADS1626 is 46 CLK cycles, regardless of the FIFO level. Therefore, for higher FIFO levels, it takes fewer $\overline{\text { DRDY }}$ cycles to settle because the DRDY period is longer. Table 4 shows the number of $\overline{\mathrm{DRDY}}$ cycles required to settle for each FIFO level.

Table 4. ADS1626 Reset Settling

| FIFO LEVEL | FILTER SETTLING TIME AFTER RESET <br> $\left(\mathbf{t}_{\mathbf{2 6}}\right.$ in units of $\overline{\text { DRDY }}$ cycles $)$ |
| :---: | :---: |
| 2 | 23 |
| 4 | 12 |
| 6 | 8 |
| 8 | 6 |
| 10 | 5 |
| 12 | 4 |
| 14 | 4 |

## SETTLING TIME

The settling time is an important consideration when measuring signals with large steps or when using a multiplexer in front of the analog inputs. The ADS1625/6 digital filter requires time for an instantaneous change in signal level to propagate to the output.
Be sure to allow the filter time to settle after applying a large step in the input signal, switching the channel on a multiplexer placed in front of the inputs, resetting the ADS1625/6, or exiting the power-down mode,

Figure 17 shows the settling error as a function of time for a full-scale signal step applied at $t=0$. This figure uses $\overline{\text { DRDY }}$ cycles for the time scale (X-axis). After 46 DRDY cycles, the settling error drops below $0.001 \%$. For f CLK $=40 \mathrm{MHz}$, this corresponds to a settling time of $36.8 \mu \mathrm{~s}$.


Figure 17. Settling Time

## IMPULSE RESPONSE

Figure 18 plots the normalized response for an input applied at $t=0$. The $X$-axis units of time are $\overline{\text { DRDY }}$ cycles. As shown in Figure 18, the peak of the impulse takes $26 \overline{\text { DRDY cycles }}$ to propagate to the output. For $\mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}$, a $\overline{\mathrm{DRDY}}$ cycle is $0.8 \mu \mathrm{~s}$ in duration and the propagation time (or group delay) is $26 \times 0.8 \mu \mathrm{~s}=20.8 \mu \mathrm{~s}$.


Figure 18. Impulse Response

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## FREQUENCY RESPONSE

The linear phase FIR digital filter sets the overall frequency response. Figure 19 shows the frequency response from dc to 20 MHz for $\mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}$. The frequency response of the ADS1625/6 filter scales directly with CLK frequency. For example, if the CLK frequency is decreased by half (to 20 MHz ), the values on the X-axis in Figure 19 would need to be scaled by half, with the span becoming dc to 10 MHz .

Figure 20 shows the passband ripple from dc to 550 kHz $\left(\mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}\right)$. Figure 21 shows a closer view of the passband transition by plotting the response from 500 kHz to 640 kHz ( $\mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}$ ).

The overall frequency response repeats at multiples of the CLK frequency. To help illustrate this, Figure 22 shows the response out to 120 MHz ( $\mathrm{f}_{\mathrm{CLK}}=40 \mathrm{MHz}$ ). Notice how the passband response repeats at $40 \mathrm{MHz}, 80 \mathrm{MHz}$ and 120 MHz ; it is important to consider this when there is high-frequency noise present with the signal. The modulator bandwidth extends to 100 MHz . High-frequency noise around 40 MHz and 80 MHz will not be attenuated by either the modulator or the digital filter. This noise will alias back in-band and reduce the overall SNR performance unless it is filtered out prior to the ADS1625/6. To prevent this, place an anti-alias filter in front of the ADS1625/6 that rolls off before 39 MHz .


Figure 19. Frequency Response.


Figure 20. Passband Ripple


Figure 21. Passband Transition


Figure 22. Frequency Response Out to 120 MHz
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## FIFO (ADS1626 ONLY)

The ADS1626 includes an adjustable level first-in first-out buffer (FIFO) for the output data. The FIFO allows data to be temporarily stored within the ADS1626 to provide more flexibility for the host controller when retrieving data. Pins FIFO_LEV[2:0] set the level or depth of the FIFO. Note that these pins must be left unconnected on the ADS1625. The FIFO is enabled by setting at least one of the FIFO_LEV inputs high. Table 5 shows the corresponding FIFO level and DRDY period for the different combinations of FIFO_LEV[2:0] settings. For the best performance when using the FIFO, it is recommended to:

1. Set IOVDD $=3 \mathrm{~V}$.
2. Synchronize data retrieval with CLK.
3. Minimize loading on outputs DOUT[17:0].
4. Ensure rise and fall times on CLK and $\overline{\mathrm{RD}}$ are 1 ns or longer.

Table 5. FIFO Buffer Level Settings for the ADS1626

| FIFO_LEV[2:0] | FIFO BUFFER LEVEL | $\overline{\text { DRDY }}$ PERIOD |
| :---: | :---: | :---: |
| 000 | 0: disabled, <br> operates like ADS1625 | $32 / \mathrm{f}$ CLK |
| 001 | 2 | $64 / \mathrm{f}$ CLK |
| 010 | 4 | $128 / \mathrm{f}$ CLK |
| 011 | 6 | $192 / \mathrm{f}$ CLK |
| 100 | 8 | $256 / \mathrm{f}$ CLK |
| 101 | 10 | $320 / \mathrm{f}$ CLK |
| 110 | 12 | $384 / \mathrm{f}$ CLK |
| 111 | 14 | $448 / \mathrm{f}$ CLK |

## FIFO Operation

The ADS1626 FIFO collects the number of output readings set by the level corresponding to the FIFO_LEV[2:0] setting. When the specified level is reached, DRDY is pulsed high, indicating the data in the FIFO is ready to be read. The DRDY period is a function of the FIFO level, as shown in Table 5. To read the data, make sure $\overline{\mathrm{CS}}$ is low (it is acceptable to tie it low) and then
take $\overline{\mathrm{RD}}$ low. The first, or oldest, data will be presented on the data output pins. After reading this data, advance to the next data reading by toggling $\overline{\mathrm{RD}}$. On the next falling edge of $\overline{\mathrm{RD}}$, the second data is present on the data output pins. Continue this way until all the data have been read from the FIFO, making sure to take $\overline{\mathrm{RD}}$ high when complete. Afterwards, wait until $\overline{\mathrm{DRDY}}$ toggles and repeat the readback cycle. Figure 23 shows an example readback when FIFO_LEV[2:0] = 010 (level = 4).

## Readback considerations

The exact number of data readings set by the FIFO level must be read back each time $\overline{\text { DRDY }}$ toggles. The one exception is that readback can be skipped entirely. In this case, the DRDY period increases to 512 CLK period. Figure 24 shows an example when readback is skipped with the FIFO level = 4. Do not read back more or less readings from the FIFO than set by the level. This interrupts the FIFO operation and can cause $\overline{\text { DRDY }}$ to stay low indefinitely. If this occurs, the RESET pin must be toggled followed by a RD pulse. This resets the ADS1626 FIFO and also the digital filter, which must settle afterwards before valid data is ready. See the section, Resetting the ADS1626, for more details.

## Setting the FIFO Level

The FIFO level setting is usually a static selection that is set when power is first applied to the ADS1626. If the FIFO level needs to be changed after powerup, there are two options. One is to asynchronously set the new value on pin FIFO_LEV[2:0] then toggle RESET. Remember that the ADS1626 will need to settle after resetting. See the section, Resetting the ADS1626, for more details. The other option avoids requiring a reset, but needs synchronization of the FIFO level change with the readback. The FIFO_LEV[2:0] pins have to be changed after $\overline{\mathrm{RD}}$ goes high after reading the first data, but before $\overline{\mathrm{RD}}$ goes low to read the last data from the FIFO. The new FIFO level becomes active immediately and the DRDY period adjusts accordingly. When decreasing the FIFO level this way, make sure to give adequate time for readback of the data before setting the new, smaller level. Figure 25 shows an example of a synchronized FIFO level change from 4 to 8 .

(1) $\overline{\mathrm{CS}}$ can be tied low.
(2) Data ${ }_{1}$ is the oldest data and Data ${ }_{4}$ is the most recent.

Figure 23. Example of FIFO Readback when FIFO Level = 4


Figure 24. Example of Skipping Readback when FIFO Level = 4


Figure 25. Example of Synchronized Change of FIFO Level from 4 to 8

## ANALOG POWER DISSIPATION

An external resistor connected between the RBIAS pin and the analog ground sets the analog current level, as shown in Figure 26. The current is inversely proportional to the resistor value. Table 6 shows the recommended values of $\mathrm{R}_{\text {BIAS }}$ for different CLK frequencies. Notice that the analog current can be reduced when using a slower frequency CLK input, because the modulator has more time to settle. Avoid adding any capacitance in parallel to $\mathrm{R}_{\text {BIAS }}$, since this will interfere with the internal circuitry used to set the biasing.


Figure 26. External Resistor Used to Set Analog Power Dissipation

Table 6. Recommended $\mathrm{R}_{\text {BIAS }}$ Resistor Values for Different CLK Frequencies

| fCLK | DATA <br> RATE | RBIAS | TYPICAL POWER <br> DISSIPATION WITH $\overline{\text { REFEN }}$ <br> HIGH |
| :---: | :---: | :---: | :---: |
| 10 MHz | 312.5 kHz | $65 \mathrm{k} \Omega$ | 150 mW |
| 20 MHz | 625 kHz | $60 \mathrm{k} \Omega$ | 305 mW |
| 30 MHz | 937.5 kHz | $50 \mathrm{k} \Omega$ | 390 mW |
| 40 MHz | 1.25 MHz | $37 \mathrm{k} \Omega$ | 515 mW |

## POWER DOWN ( $\overline{\mathrm{PD}})$

When not in use, the ADS1625/6 can be powered down by taking the $\overline{\mathrm{PD}}$ pin low. All circuitry will be shutdown, including the voltage reference. To minimize the digital current during power down, stop the clock signal supplied to the CLK input. There is an internal pull-up resistor of $170 \mathrm{k} \Omega$ on the $\overline{\mathrm{PD}}$ pin, but it is recommended that this pin be connected to IOVDD if not used. If using the ADS1626 with the FIFO enabled, issue a reset after exiting the power-down mode. Make sure to allow time for the reference to start up after exiting power-down mode. The internal reference typically requires 15 ms . After the reference has stabilized, allow at least 100 $\overline{\text { DRDY }}$ cycles for the modulator and digital filter to settle before retrieving data.

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## POWER SUPPLIES

Three supplies are used on the ADS1625/6: analog (AVDD), digital (DVDD) and digital I/O (IOVDD). Each supply must be suitably bypassed to achieve the best performance. It is recommended that a $1 \mu \mathrm{~F}$ and $0.1 \mu \mathrm{~F}$ ceramic capacitor be placed as close to each supply pin as possible. Connect each supply-pin bypass capacitor to the
associated ground, as shown in Figure 27. Each main supply bus should also be bypassed with a bank of capacitors from $47 \mu \mathrm{~F}$ to $0.1 \mu \mathrm{~F}$, as shown.
The IO and digital supplies (IOVDD and DVDD) can be connected together when using the same voltage. In this case, only one bank of $47 \mu \mathrm{~F}$ to $0.1 \mu \mathrm{~F}$ capacitors is needed on the main supply bus, though each supply pin must still be bypassed with a $1 \mu \mathrm{~F}$ and $0.1 \mu \mathrm{~F}$ ceramic capacitor.


Figure 27. Recommended Power-Supply Bypassing

ADS1625

## LAYOUT ISSUES

The ADS1625/6 is a very high-speed, high-resolution data converter. In order to achieve the maximum performance, careful attention must be given to the printed circuit board (PCB) layout. Use good high-speed techniques for all circuitry. Critical capacitors should be placed close to pins as possible. These include capacitors directly connected to the analog and reference inputs and the power supplies. Make sure to also properly bypass all circuitry driving the inputs and references.

There are two possible approaches for the ground plane on the PCB: a single common plane or two separate planes, one for the analog grounds and one for the digital grounds. When using only one common plane, isolate the flow of current on pin 58 from pin 1; use breaks on the ground plane to accomplish this. Pin 58 carries the switching current from the analog clocking for the modulator and can corrupt the quiet analog ground on pin 1. When using two planes, it is recommended that they be tied together right at the PCB. Do not try to connect the ground planes together after running separately through edge connectors or cables as this reduces performance and increases the likelihood of latchup.

In general, keep the resistances used in the driving circuits for the inputs and reference low to prevent excess thermal noise from degrading overall performance. Avoid having the ADS1625/6 digital outputs drive heavy loads. Buffers on the outputs are recommended unless the ADS1625/6 is connected directly to a DSP or controller situated nearby. Additionally, make sure the digital inputs are driven with clean signals as ringing on the inputs can introduce noise.

The ADS1625/6 uses TI PowerPAD technology. The PowerPAD is physically connected to the substrate of the silicon inside the package and must be soldered to the analog ground plane on the PCB using the exposed metal pad underneath the package for proper heat dissipation. Please refer to application report SLMA002, located at www.ti.com, for more details on the PowerPAD package.

## APPLICATIONS

## INTERFACING THE ADS1625 TO THE TMS320C6000

Figure 28 illustrates how to directly connect the ADS1625 to the TMS320C6000 DSP. The processor controls reading using output ARE. The ADS1625 is selected using the DSP control output, $\overline{C E 2}$. The ADS1625 18-bit data output bus is directly connected to the TMS320C6000 data bus. The data ready output from the ADS1625, DRDY, drives interrupt EXT_INT7 on the TMS320C6000.


Figure 28. ADS1625-TMS320C6000 Interface Connection

## INTERFACING THE ADS1626 TO THE TMS320C6000

Figure 29 illustrates how to directly connect the ADS1626 to the TMS320C6000 DSP. The processor controls reading using output $\overline{\text { ARE. The ADS1626 is permanently }}$ selected by grounding the CS pin. The ADS1626 18-bit data output bus is directly connected to the TMS320C6000 data bus. The data ready output from the ADS1626, DRDY, drives interrupt EXT_INT7 on the TMS320C6000.


Figure 29. ADS1626-TMS320C6000 Interface Connection
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## INTERFACING THE ADS1625 TO THE TMS320VC5510

Figure 30 illustrates how to connect the ADS1625 to the TMS320VC5510 DSP. The DSP controls reading using output $\overline{\text { ARE. The ADS1625 is selected using the DSP }}$ control output $\overline{\text { CE2 }}$. The ADS1625 18-bit data output bus is directly connected to the TMS320VC5510 data bus. The data ready output from the ADS1625, $\overline{\text { DRDY, drives the }}$ INT3 interrupt line on the TMS320VC5510.


Figure 30. ADS1625-TMS320VC5510 Interface Connection

## INTERFACING THE ADS1626 TO THE TMS320VC5510

Figure 31 illustrates how to directly connect the ADS1626 to the TMS320VC5510 Digital Signal Processor. The processor controls reading the ADC using the $\overline{\text { ARE output. }}$ The ADS1626 is permanently selected by grounding the $\overline{\mathrm{CS}}$ pin. If there are any additional devices connected to the TMS320VC5510 I/O space, address decode logic will be required between the ADC and the DSP to prevent data bus contention and ensure that only one device at a time is selected. The ADS1626 18-bit data output bus is directly connected to the TMS320VC5510. The data ready output from the ADS1626, $\overline{\text { DRDY, }}$ drives interrupt $\overline{\mathrm{INT3}}$ on the TMS320VC5510.


Figure 31. ADS1626-TMS320VC5510 Interface Connection

Code Composer Studio, available from TI, provides support for interfacing TI DSPs through a collection of data converter plugins. Check the TI web site, located at www.ti.com/sc/dcplug-in, for the latest information on ADS1625/6 support.

## PACKAGING INFORMATION

| Orderable Device | Status ${ }^{(1)}$ | Package <br> Type | Package <br> Drawing | Pins Package <br> Qty | Eco Plan ${ }^{(2)}$ | Lead/Ball Finish | MSL Peak Temp ${ }^{(3)}$ |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| ADS1625IPAPR | ACTIVE | HTQFP | PAP | 64 | 1000 | None | CU NIPDAU | Level-3-235C-168 HR |
| ADS1625IPAPT | ACTIVE | HTQFP | PAP | 64 | 250 | None | CU NIPDAU | Level-3-235C-168 HR |
| ADS1626IPAPR | ACTIVE | HTQFP | PAP | 64 | 1000 | None | CU NIPDAU | Level-3-235C-168 HR |
| ADS1626IPAPT | ACTIVE | HTQFP | PAP | 64 | 250 | None | CU NIPDAU | Level-3-235C-168 HR |

${ }^{(1)}$ The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.
${ }^{(2)}$ Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
None: Not yet available Lead (Pb-Free).
Pb -Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed $0.1 \%$ by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.
Green (RoHS \& no $\mathbf{S b} / \mathbf{B r}$ ): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine ( Br ) or antimony $(\mathrm{Sb})$ above $0.1 \%$ of total product weight.
${ }^{(3)}$ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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PAP (S-PQFP-G64) PowerPAD ${ }^{\text {TM }}$ PLASTIC QUAD FLATPACK


4147702/C 08/03
NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion
D. This package is designed to be soldered to a thermal pad on the board. Refer to Technical Brief, PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 for information regarding recommended board layout. This document is available at www.ti.com <http: //www.ti.com>.
E. Falls within JEDEC MS-026

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